

Preliminary_MS17N03Q8

N-Channel Logic Level Enhancement Mode MOSFET

Description

MS17N03Q8 provides the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost effectiveness.

The SOP-8 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

Features

- $R_{DS(ON)}=15m\Omega(max.)@V_{GS}=10V, I_D=10A$
- Simple drive requirement
- Low on-resistance
- Fast switching speed
- RoHS compliant package

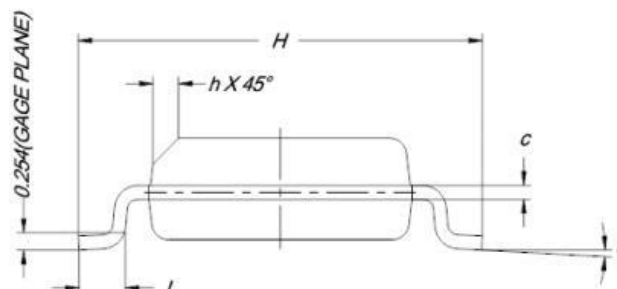
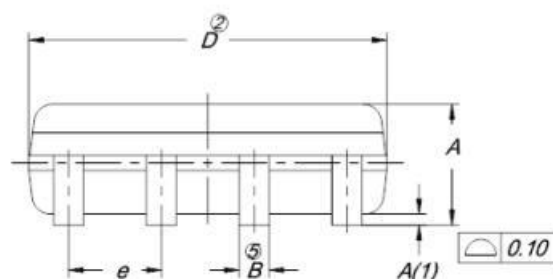
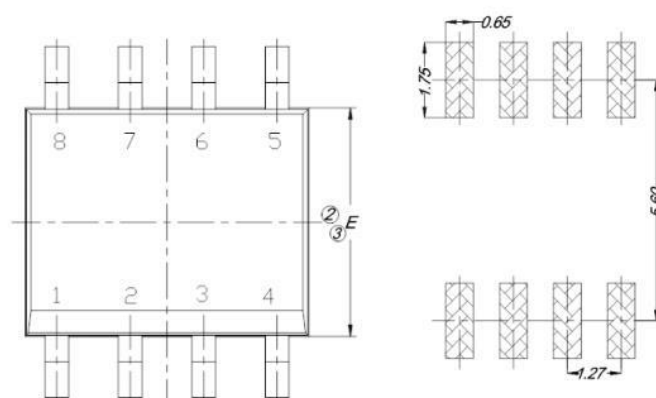
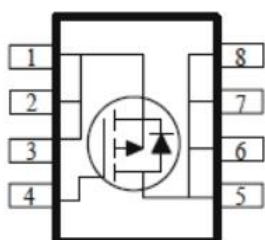
Packing & Order Information

3,000/Reel



**RoHS
COMPLIANT**

Graphic symbol



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	1.35	1.55	1.75
A(1)	0.10	0.18	0.25
B	0.38	0.45	0.51
C	0.19	0.22	0.25
D	4.80	4.90	5.00
E	3.80	3.90	4.00
e	1.27 BSC		
H	5.80	6.00	6.20
L	0.50	0.72	0.93
α	0°	4°	8°
h	0.25	0.38	0.50

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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current -Continuous (TC=25°C)	10	A
	Drain Current -Continuous (TC=100°C)	8	A
I_{DM}	Pulsed Drain Current (Note 1)	40	A
I_{AS}	Avalanche Current	12	A
E_{AS}	Avalanche Energy @ L=0.1mH , $I_D=10A$, $R_G=25\Omega$	5	mJ
E_{AR}	Repetitive Avalanche Energy @ L=0.005mH (Note 2)	2.5	mJ
P_D	Power Dissipation ($T_A=25^\circ C$) (Note 3)	3	W
	Power Dissipation ($T_A=100^\circ C$)	1.5	W
T_J/T_{STG}	Operating Junction and Storage Temperature Range	-55 to +175	°C

100% UIS testing in condition of $V_D=15V$, $L=0.1mH$, $V_G=10V$, $I_L=10A$, Rated $V_{DS}=30V$ N-CH

Thermal Data

Symbol	Parameter	Max.	Units
R_{thj-c}	Thermal Resistance, Junction-to-Case, max	25	°C/W
R_{thj-a}	Thermal Resistance, Junction-to-Ambient, max	50*3	

Note:

1. Pulse width limited by maximum junction temperature.
2. Duty cycle $\leq 1\%$
3. Surface mounted on 1 in2 copper pad of FR-4 board, 125°C/W when mounted on minimum copper pad.

Characteristics (Tj=25°C, unless otherwise specified)

Symbol	Test Conditions	Min	Typ.	Max.	Units
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	1	1.5	3	V
BV_{DSS}	$V_{GS} = 0V$, $I_D = 250\mu A$	30	--	--	V
G_{FS}^{*1}	$V_{DS} = 5V$, $I_D = 10A$	--	80	--	S
I_{GSS}	$V_{GS} = \pm 20$	--	--	± 100	nA
I_{DSS}	$V_{DS} = 24V$, $V_{GS} = 0V$	--	--	10	uA
	$V_{DS} = 20V$, $V_{GS} = 0V$, $T_J = 125^\circ C$			25	
$I_{D(ON)}^{*1}$	$V_{GS} = 10V$, $I_D = 10A$	10	--	--	A
$R_{DS(ON)}^{*1}$	$V_{GS} = 10V$, $I_D = 10A$	--	13	15	mΩ
	$V_{GS} = 4.5V$, $I_D = 6A$	--	20	25	

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Dynamic					
Symbol	Test Conditions	Min	Typ.	Max.	Units
$Q_g(V_{GS}=10V)$ *1.2	$V_{DS} = 15 V, I_D = 10 A, V_{GS} = 10 V$	--	11	--	nC
$Q_{gs}(V_{GS}=4.5V)$ *1.2		--	6	--	nC
Q_{gs} *1.2			1.2		nC
Q_{gd} *1.2		--	3.3	--	nC
$t_{d(on)}$ *1.2	$V_{DS} = 15 V, I_D = 1 A, V_{GS} = 10 V$ $R_G = 25 \Omega, R_D = 15 \Omega$	--	11	--	ns
t_r *1.2		--	16	--	ns
$t_{d(off)}$ *1.2		--	36	--	ns
t_f *1.2		--	20	--	ns
C_{ISS}	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1.0MHz$	--	1115	--	pF
C_{OSS}		--	116	--	pF
C_{RSS}		--	82	--	pF
R_g	$V_{DS} = 15mV, V_{GS} = 0 V, f = 1.0MHz$	--	2	--	Ω

Source-Drain Diode					
Symbol	Test Conditions	Min	Typ.	Max.	Units
I_S *1		--	--	2.3	A
I_{SM} *3		--	--	9.2	
V_{SD} *1	$I_F = I_S, V_{GS} = 0 V$	--	--	102	V
t_{rr}	$I_F = I_S, di/dt = 100A/\mu s$	--	50	--	ns
Q_{rr}		--	2	--	μC

Notes:

1. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
2. Independent of operating temperature.
3. Pulse width limited by maximum junction temperature.

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